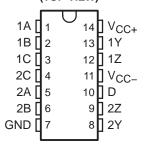
- Improved Stability Over Supply Voltage and Temperature Ranges
- Constant-Current Outputs
- High Speed
- Standard Supply Voltages
- High Output Impedance
- High Common-Mode Output Voltage Range
   ... –3 V to 10 V
- TTL-Input Compatibility
- Inhibitor Available for Driver Selection
- Glitch Free During Power Up/Power Down
- SN75112 and External Circuit Meets or Exceeds the Requirements of CCITT Recommendation V.35

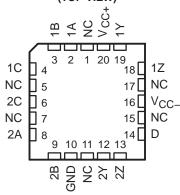
#### description/ordering information

The SN55110A, SN75110A, and SN75112 dual line drivers have improved output current regulation with supply-voltage and temperature variations. In addition, the higher current of the SN75112 (27 mA) allows data to be transmitted over longer lines. These drivers offer optimum performance when used with the SN55107A, SN75107A, and SN75108A line receivers.

SN55110A ... J OR W PACKAGE SN75110A ... D, N, OR NS PACKAGE SN75112 ... D OR N PACKAGE (TOP VIEW)



SN55110A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

#### ORDERING INFORMATION

| TA             | PACKA     | GE†          | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|-----------|--------------|--------------------------|---------------------|
|                | DDID (N)  | Tube of 25   | SN75110AN                | SN75110AN           |
|                | PDIP (N)  | Tube of 25   | SN75112N                 | SN75112N            |
|                |           | Tube of 50   | SN75110AD                | CNZE44OA            |
| 0°C to 70°C    | COIC (D)  | Reel of 2500 | SN75110ADR               | SN75110A            |
|                | SOIC (D)  | Tube of 50   | SN75112D                 | ON75440             |
|                |           | Reel of 2500 | SN75112DR                | SN75112             |
|                | SOP (NS)  | Reel of 2000 | SN75110ANSR              | SN75110A            |
|                | ODID (I)  | Tube of 05   | SN55110AJ                | SN55110AJ           |
| –55°C to 125°C | CDIP (J)  | Tube of 25   | SNJ55110AJ               | SNJ55110AJ          |
| -55 C to 125 C | CFP (W)   | Tube of 150  | SNJ55110AW               | SNJ55110AW          |
|                | LCCC (FK) | Tube of 55   | SNJ55110AFK              | SNJ55110AFK         |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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#### description/ordering information (continued)

These drivers feature independent channels with common voltage supply and ground terminals. The significant difference between the three drivers is in the output-current specification. The driver circuits feature a constant output current that is switched to either of two output terminals by the appropriate logic levels at the input terminals. The output current can be switched off (inhibited) by low logic levels on the enable inputs. The output current nominally is 12 mA for the '110A devices and is 27 mA for the SN75112.

The enable/inhibit feature is provided so the circuits can be used in party-line or data-bus applications. A strobe or inhibitor (enable D), common to both drivers, is included for increased driver-logic versatility. The output current in the inhibited mode,  $I_{O(off)}$ , is specified so that minimum line loading is induced when the driver is used in a party-line system with other drivers. The output impedance of the driver in the inhibited mode is very high. The output impedance of a transistor is biased to cutoff.

The driver outputs have a common-mode voltage range of –3 V to 10 V, allowing common-mode voltage on the line without affecting driver performance.

All inputs are diode clamped and are designed to satisfy TTL-system requirements. The inputs are tested at 2 V for high-logic-level input conditions and 0.8 V for low-logic-level input conditions. These tests ensure 400-mV noise margin when interfaced with TTL Series 54/74 devices.

The SN55110A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN75110A and SN75112 are characterized for operation from 0°C to 70°C.

# FUNCTION TABLE (each driver)

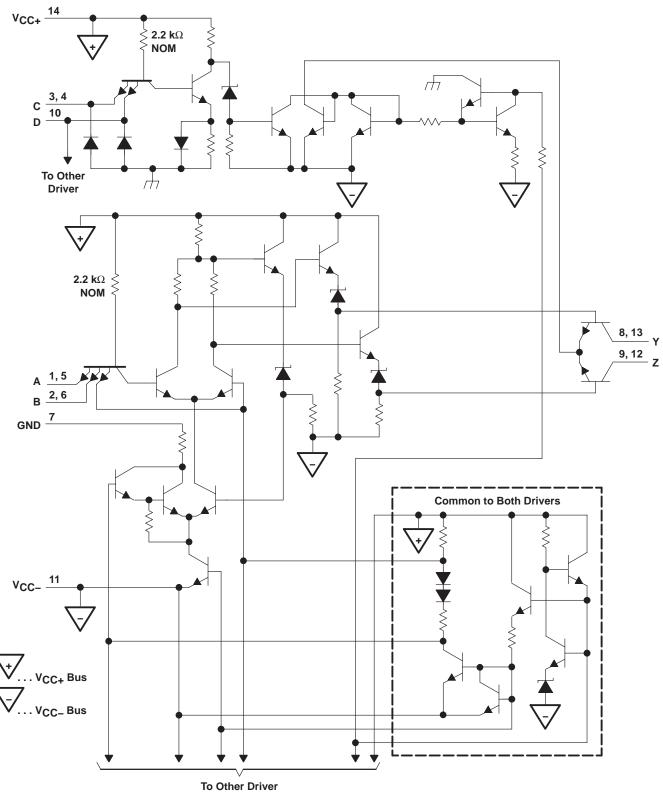
|   | GIC<br>UTS |   | BLE<br>UTS | оитритѕ† |     |  |
|---|------------|---|------------|----------|-----|--|
| Α | В          | С | D          | Υ        | Z   |  |
| Х | Х          | L | Х          | Off      | Off |  |
| Х | X          | Χ | L          | Off      | Off |  |
| L | X          | Н | Н          | On       | Off |  |
| Х | L          | Н | Н          | On       | Off |  |
| Н | Н          | Н | Н          | Off      | On  |  |

H = high level, L = low level, X = irrelevant



<sup>†</sup> When using only one channel of the line drivers, the other channel should be inhibited and/or have its outputs grounded.

## schematic (each driver)



Pin numbers shown are for the D, J, N, NS, and W packages.



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### absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

|                             | ľ                                                                                                                                                                                                                                                                                                  |
|-----------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                             | 'V                                                                                                                                                                                                                                                                                                 |
|                             | V                                                                                                                                                                                                                                                                                                  |
|                             |                                                                                                                                                                                                                                                                                                    |
| D package 86°C/             | /W                                                                                                                                                                                                                                                                                                 |
|                             |                                                                                                                                                                                                                                                                                                    |
| NS package 76°C/            | /W                                                                                                                                                                                                                                                                                                 |
| FK package 13.42°C/         | /W                                                                                                                                                                                                                                                                                                 |
|                             |                                                                                                                                                                                                                                                                                                    |
| W package 14.65°C/          | /W                                                                                                                                                                                                                                                                                                 |
|                             | °C                                                                                                                                                                                                                                                                                                 |
|                             | °C                                                                                                                                                                                                                                                                                                 |
| seconds: J or W package 300 | °C                                                                                                                                                                                                                                                                                                 |
| –65°C to 150                | °C                                                                                                                                                                                                                                                                                                 |
|                             | D package       86°C/N package         N package       80°C/NS package         FK package       13.42°C/NS package         J package       15.05°C/NS package         W package       14.65°C/NS package         150°C/NS package       150°C/NS package         260°S package       300°S package |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. Voltage values are with respect to network ground terminal.
  - 2. Maximum power dissipation is a function of T<sub>J</sub>(max), θ<sub>JA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.
  - 4. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JC}$ , and  $T_C$ . The maximum allowable power dissipation at any allowable case temperature is  $P_D = (T_J(max) - T_C)/\theta_JC$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.
  - 5. The package thermal impedance is calculated in accordance with MIL-STD-883.

### recommended operating conditions (see Note 6)

|                   |                                     | SN55110A SN75110A SN75112 |     |      |       | UNIT |       |    |
|-------------------|-------------------------------------|---------------------------|-----|------|-------|------|-------|----|
|                   |                                     | MIN                       | NOM | MAX  | MIN   | NOM  | MAX   |    |
| VCC+              | Supply voltage                      | 4.5                       | 5   | 5.5  | 4.75  | 5    | 5.25  | V  |
| V <sub>CC</sub> - | Supply voltage                      | -4.5                      | -5  | -5.5 | -4.75 | -5   | -5.25 | V  |
|                   | Positive common-mode output voltage | 0                         |     | 10   | 0     |      | 10    | V  |
|                   | Negative common-mode output voltage | 0                         |     | -3   | 0     |      | -3    | V  |
| VIH               | High-level input voltage            | 2                         |     |      | 2     |      |       | V  |
| V <sub>IL</sub>   | Low-level output voltage            |                           |     | 0.8  |       |      | 0.8   | V  |
| TA                | Operating free-air temperature      | -55                       |     | 125  | 0     |      | 70    | °C |

NOTE 6: When using only one channel of the line drivers, the other channel should be inhibited and/or have its outputs grounded.



# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                       | PARAMET                                                          | ER                | TEST CON                                                                     | DITIONS†               | _   | N55110 <i>A</i> | · .  | ;   | SN75112 |      | UNIT |
|-----------------------|------------------------------------------------------------------|-------------------|------------------------------------------------------------------------------|------------------------|-----|-----------------|------|-----|---------|------|------|
|                       |                                                                  |                   |                                                                              |                        | MIN | TYP‡            | MAX  | MIN | TYP‡    | MAX  |      |
| VIK                   | Input clamp vo                                                   | oltage            | $V_{CC\pm} = MIN$ , $I_L = -12 \text{ mA}$                                   |                        |     | -0.9            | -1.5 |     | -0.9    | -1.5 | V    |
|                       |                                                                  |                   | $V_{CC\pm} = MAX$ ,                                                          | V <sub>O</sub> = 10 V  |     | 12              | 15   |     | 27      | 40   |      |
| I <sub>O(on)</sub>    | On-state outp                                                    | ut current        | $V_{CC} = MIN \text{ to } M$ $V_{O} = -1 \text{ V to } 1 \text{ V}$          |                        |     |                 |      | 24  | 28      | 32   | mA   |
|                       |                                                                  |                   | $V_{CC\pm} = MIN,$                                                           | $V_O = -3 V$           | 6.5 | 12              |      | 15  | 27      |      |      |
| IO(off)               | Off-state outpo                                                  | ut current        | $V_{CC\pm} = MIN$ ,                                                          | V <sub>O</sub> = 10 V  |     |                 | 100  |     |         | 100  | μΑ   |
|                       | Input current                                                    | A, B, or C inputs |                                                                              | \                      |     |                 | 1    |     |         | 1    | 4    |
| 1                     | at maximum<br>input voltage                                      | D input           | $V_{CC\pm} = MAX$ ,                                                          | V <sub>I</sub> = 5.5 V |     |                 | 2    |     |         | 2    | mA   |
|                       | High-level                                                       | A, B, or C inputs | .,                                                                           | .,                     |     |                 | 40   |     |         | 40   |      |
| <sup>1</sup> IH       | input current                                                    | D input           | $V_{CC\pm} = MAX$ ,                                                          | V <sub>I</sub> = 2.4 V |     |                 | 80   |     |         | 80   | μΑ   |
|                       | Low-level                                                        | A, B, or C inputs | .,                                                                           | V 0.4V                 |     |                 | -3   |     |         | -3   | 4    |
| lIF.                  | input current                                                    | D input           | $V_{CC\pm} = MAX$ ,                                                          | V  = 0.4 V             |     |                 | -6   |     |         | -6   | mA   |
| I <sub>CC+(on)</sub>  | Supply curren with driver ena                                    | 00                | V <sub>CC±</sub> = MAX,<br>A and B inputs a<br>C and D inputs a              |                        |     | 23              | 35   |     | 25      | 40   | mA   |
| I <sub>CC</sub> -(on) | Supply current from V <sub>CC</sub> _  -(on) with driver enabled |                   | V <sub>CC±</sub> = MAX,<br>A and B inputs at 0.4 V,<br>C and D inputs at 2 V |                        |     | -34             | -50  |     | -65     | -100 | mA   |
| ICC+(off)             | Supply current from V <sub>CC</sub> – with driver inhibited      |                   | V <sub>CC±</sub> = MAX,<br>A, B, C, and D ir                                 | nputs at 0.4 V         |     | 21              |      |     | 30      |      | mA   |
| ICC-(off)             | Supply curren with driver inh                                    |                   | $V_{CC\pm} = MAX$ , A, B, C, and D in                                        | nputs at 0.4 V         | _   | -17             |      |     | -32     | _    | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC\pm}$ = $\pm 5$ V, $T_A$ = 25°C (see Figure 1)

| PARAMETER§       | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CO                | MIN                 | TYP | MAX | UNIT |    |
|------------------|-----------------|----------------|------------------------|---------------------|-----|-----|------|----|
| t <sub>PLH</sub> | A = = D         | V 7            | C: 40 mF               | D: 500              |     | 9   | 15   |    |
| t <sub>PHL</sub> | A or B          | Y or Z         | $C_L = 40 pF$          | $R_L = 50 \Omega$ , |     | 9   | 15   | ns |
| t <sub>PLH</sub> | C or D          | Y or Z         | C: - 40 pF             | P. – 50 O           |     | 16  | 25   | 20 |
| t <sub>PHL</sub> | COLD            | 1 01 2         | $C_L = 40 \text{ pF},$ | $R_L = 50 \Omega$ , |     | 13  | 25   | ns |

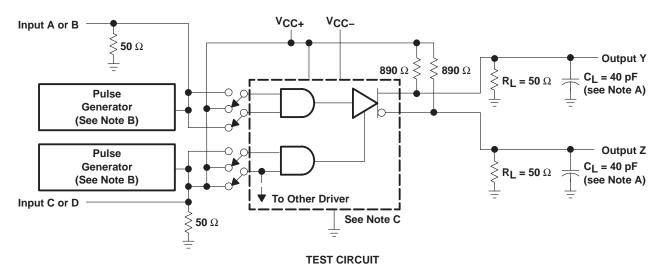
 $<sup>\</sup>S$  tpLH = propagation delay time, low- to high-level output

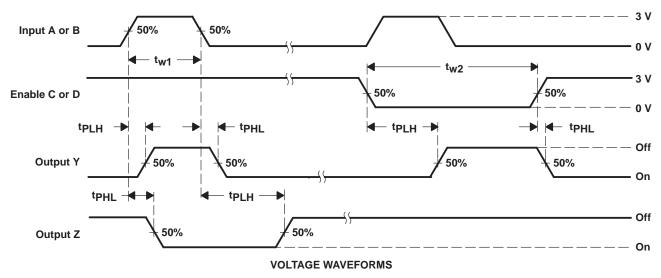


<sup>&</sup>lt;sup>‡</sup> All typical values are at  $V_{CC+} = 5 \text{ V}$ ,  $V_{CC-} = -5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

 $t_{\mbox{\footnotesize{PHL}}}$  = propagation delay time, high- to low-level output

#### PARAMETER MEASUREMENT INFORMATION



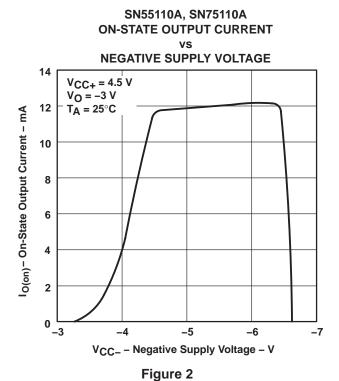


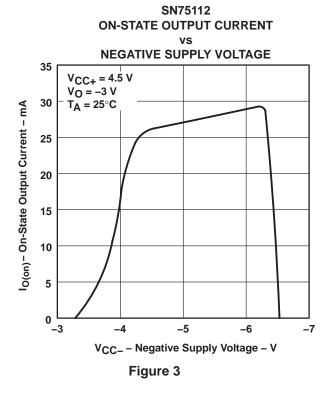
NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. The pulse generators have the following characteristics:  $Z_O = 50 \ \Omega$ ,  $t_\Gamma = t_f = 10 \pm 5$  ns,  $t_{W1} = 500$  ns, PRR  $\leq$  1 MHz,  $t_{W2} = 1 \ \mu s$ , PRR  $\leq$  500 kHz.
- C. For simplicity, only one channel and the enable connections are shown.

Figure 1. Test Circuit and Voltage Waveforms

#### **TYPICAL CHARACTERISTICS**





#### **APPLICATION INFORMATION**

### special pulse-control circuit

Figure 4 shows a circuit that can be used as a pulse-generator output or in many other testing applications.

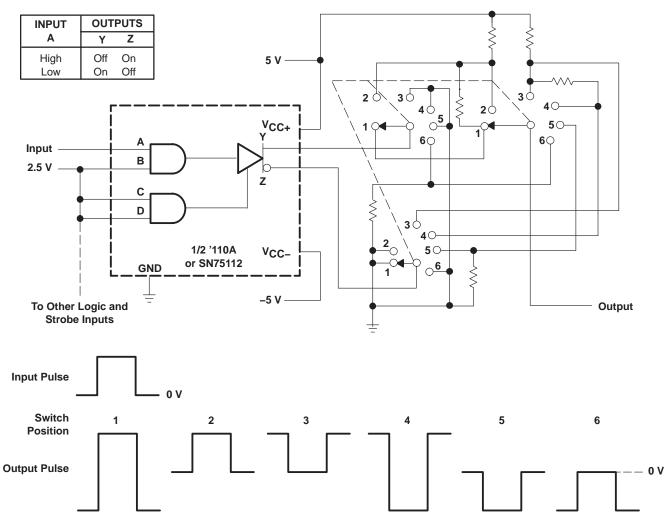


Figure 4. Pulse-Control Circuit

#### **APPLICATION INFORMATION**

### using the SN75112 as a CCITT-recommended V.35 line driver

The SN75112 dual line driver, the SN75107A dual line receiver, and some external resistors can be used to implement the data-interchange circuit of CCITT recommendation V.35 (1976) modem specification. The circuit of one channel is shown in Figure 5 and meets the requirement of the interface as specified by Appendix 11 of CCITT V.35 and is summarized in Table 1 (V.35 has been replaced by ITU V.11).

| GENERATOR                             | MIN  | MAX                        | UNIT |
|---------------------------------------|------|----------------------------|------|
| Source impedance, Z <sub>source</sub> | 50   | 150                        | Ω    |
| Resistance to ground, R               | 135  | 165                        | Ω    |
| Differential output voltage, VOD      | 440  | 660                        | mV   |
| 10% to 90% rise time, t <sub>r</sub>  | 40   |                            | ns   |
| or                                    |      | $0.01 \times ui^{\dagger}$ |      |
| Common-mode output voltage, VOC       | -0.6 | 0.6                        | V    |
| LOAD (RECEIVER)                       | MIN  | MAX                        | UNIT |
| Input impedance, Z <sub>I</sub>       | 90   | 110                        | Ω    |
| Resistance to ground, R               | 135  | 165                        | Ω    |

**Table 1. CCITT V.35 Electrical Requirements** 

<sup>†</sup> ui = unit interval or minimum signal-element pulse duration

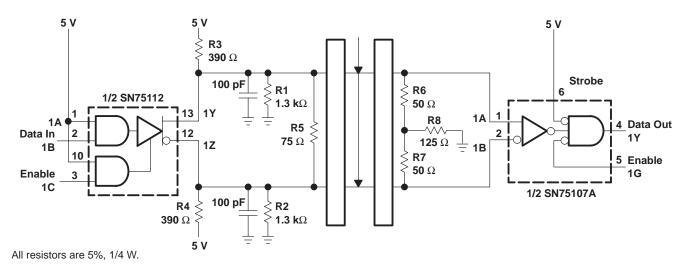


Figure 5. CCITT-Recommended V.35 Interface Using the SN75112 and SN75107A





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#### **PACKAGING INFORMATION**

| Orderable Device |          | Package Type | _       | Pins | _    |                            | Lead/Ball Finish |                    | Op Temp (°C) | Device Marking                        | Samples |
|------------------|----------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|---------------------------------------|---------|
|                  | (1)      |              | Drawing |      | Qty  | (2)                        |                  | (3)                |              | (4/5)                                 |         |
| 5962-87547012A   | ACTIVE   | LCCC         | FK      | 20   | 1    | TBD                        | POST-PLATE       | N / A for Pkg Type | -55 to 125   | 5962-<br>87547012A<br>SNJ55<br>110AFK | Samples |
| 5962-8754701CA   | ACTIVE   | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | 5962-8754701CA<br>SNJ55110AJ          | Samples |
| 5962-8754701DA   | ACTIVE   | CFP          | W       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | 5962-8754701DA<br>SNJ55110AW          | Samples |
| SN55110AJ        | ACTIVE   | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | SN55110AJ                             | Samples |
| SN75110AD        | ACTIVE   | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75110A                              | Samples |
| SN75110ADE4      | ACTIVE   | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75110A                              | Samples |
| SN75110ADG4      | ACTIVE   | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75110A                              | Samples |
| SN75110ADR       | ACTIVE   | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75110A                              | Samples |
| SN75110ADRE4     | ACTIVE   | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75110A                              | Samples |
| SN75110ADRG4     | ACTIVE   | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75110A                              | Samples |
| SN75110AJ        | OBSOLETI | E CDIP       | J       | 14   |      | TBD                        | Call TI          | Call TI            | 0 to 70      |                                       |         |
| SN75110AN        | ACTIVE   | PDIP         | N       | 14   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN75110AN                             | Samples |
| SN75110ANE4      | ACTIVE   | PDIP         | N       | 14   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN75110AN                             | Samples |
| SN75110ANSR      | ACTIVE   | so           | NS      | 14   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75110A                              | Samples |
| SN75110ANSRE4    | ACTIVE   | so           | NS      | 14   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75110A                              | Samples |
| SN75110ANSRG4    | ACTIVE   | so           | NS      | 14   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75110A                              | Samples |
| SN75112D         | ACTIVE   | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75112                               | Samples |





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| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5)                  | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|---------------------------------------|---------|
| SN75112DE4       | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75112                               | Samples |
| SN75112DG4       | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75112                               | Samples |
| SN75112DR        | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75112                               | Samples |
| SN75112DRE4      | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75112                               | Samples |
| SN75112DRG4      | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | SN75112                               | Samples |
| SN75112N         | ACTIVE | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN75112N                              | Samples |
| SN75112NE4       | ACTIVE | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN75112N                              | Samples |
| SNJ55110AFK      | ACTIVE | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type | -55 to 125   | 5962-<br>87547012A<br>SNJ55<br>110AFK | Samples |
| SNJ55110AJ       | ACTIVE | CDIP         | J                  | 14   | 1              | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | 5962-8754701CA<br>SNJ55110AJ          | Samples |
| SNJ55110AW       | ACTIVE | CFP          | W                  | 14   | 1              | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | 5962-8754701DA<br>SNJ55110AW          | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.





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- (3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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#### OTHER QUALIFIED VERSIONS OF SN55110A, SN75110A:

Catalog: SN75110A

Military: SN55110A

NOTE: Qualified Version Definitions:

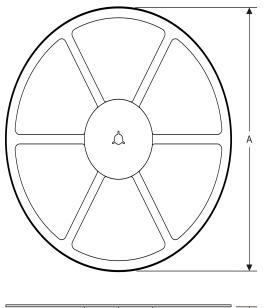
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

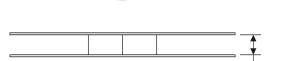
# PACKAGE MATERIALS INFORMATION

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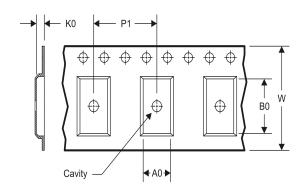
### TAPE AND REEL INFORMATION

#### **REEL DIMENSIONS**





#### **TAPE DIMENSIONS**



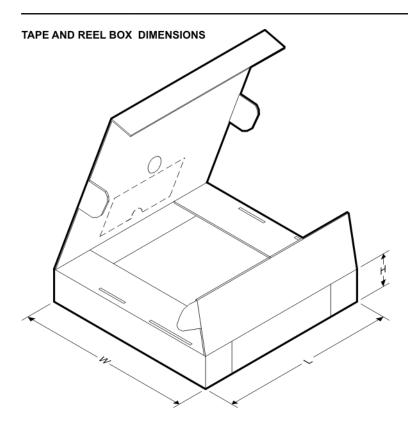
| A0 | Dimension designed to accommodate the component width     |
|----|-----------------------------------------------------------|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### TAPE AND REEL INFORMATION

#### \*All dimensions are nominal

| All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                     | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN75110ADR                 | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN75110ADR                 | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN75110ANSR                | SO              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| SN75112DR                  | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |

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\*All dimensions are nominal

| 7 til dillionorio di o morninar |              |                 |      |      |             |            |             |
|---------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| SN75110ADR                      | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| SN75110ADR                      | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN75110ANSR                     | SO           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| SN75112DR                       | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |

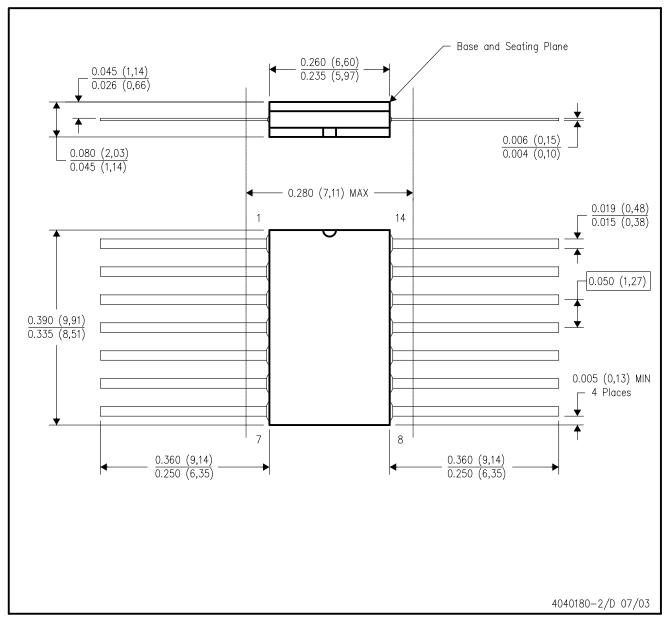
#### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# W (R-GDFP-F14)

# CERAMIC DUAL FLATPACK



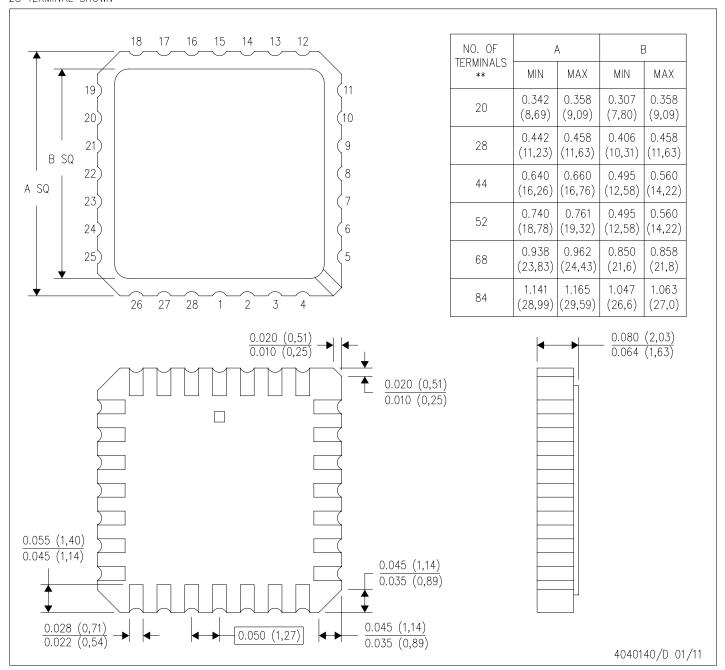
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



# FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



# N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

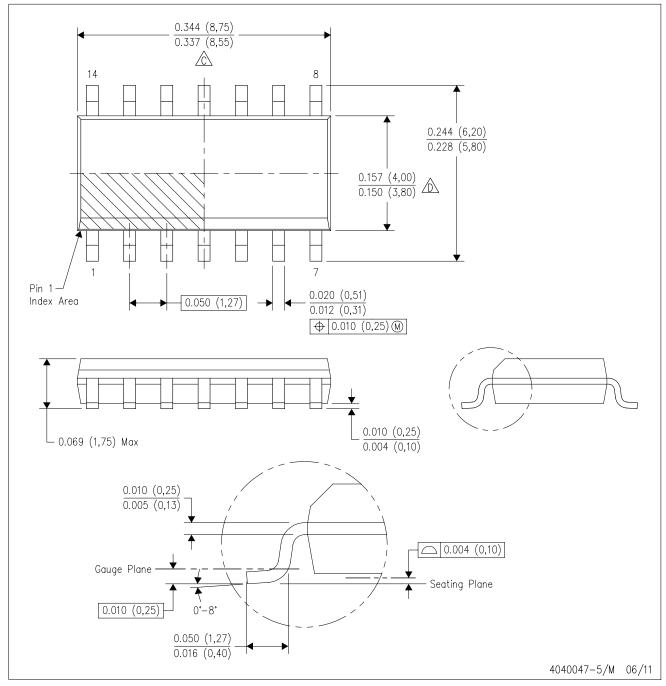


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDSO-G14)

### PLASTIC SMALL OUTLINE

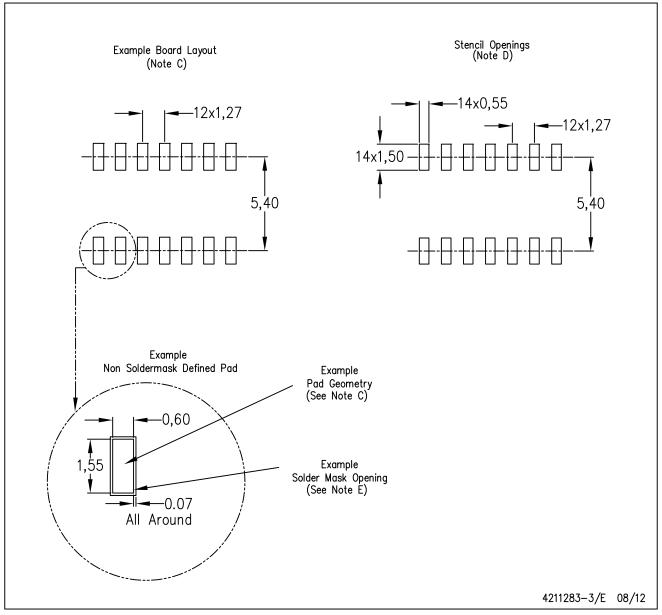


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



### **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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